

PATENT ASSIGNMENT

Electronic Version v1.1

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| Frederic DUPONT | 03/18/2005 |
| RECEIVING PARTY DATA | |
| Name: | S.O.I.TEC SILICON ON INSULATOR TECHNOLOGIES, S.A. |
| Street Address: | Parc Technologique des Fontaines, |
| City: | F-38190 Bernin |
| State/Country: | FRANCE |
| Postal Code: | F-38190 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 11084553 |
| CORRESPONDENCE DATA | |
| Fax Number: | (212)294-4700 |
| <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> | |
| Phone: | 2122946700 |
| Email: | dkumar@winston.com |
| Correspondent Name: | Allan A. Fanucci |
| Address Line 1: | 1700 K Street, N.W. |
| Address Line 4: | Washington, DISTRICT OF COLUMBIA 20006 |
| NAME OF SUBMITTER: | Allan A. Fanucci |
| Total Attachments: 2 source=assignment 4717-16700#page1.tif source=assignment 4717-16700#page2.tif | |

CH \$40.00 11084553

ASSIGNMENT

WHEREAS,

Frederic DUPONT, a citizen of France, residing at
7d, Chemin Barral, 38100 Grenoble, France.

ASSIGNOR, is the inventor of the invention entitled:

METHODS FOR FABRICATING COMPOUND MATERIAL WAFERS

for which he has executed an application for a Patent of the United States

- ☒ which is identified by Docket No. 4717-16700
☐ which was filed on _____ as Application No. _____

WHEREAS, **S.O.I.TEC SILICON ON INSULATOR TECHNOLOGIES, S.A.**, a French corporate body having a place of business at Parc Technologique des Fontaines, F-38190 Bernin, France, ASSIGNEE, is desirous of obtaining the inventor's entire right, title and interest in, to and under the said invention and the said application.

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the inventor in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, his or her entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof;

And the ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks of the United States, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

And the ASSIGNOR hereby covenants and agrees that he or she has the full right to convey the entire interest herein assigned, and that he or she has not executed, and will not execute, any agreement in conflict herewith;

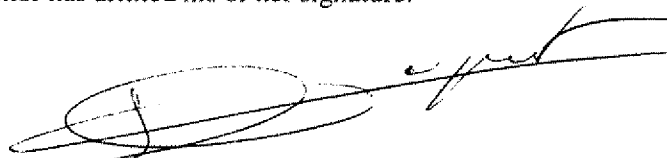
And the ASSIGNOR hereby further covenants and agrees that he or she will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to him or her respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, and reissue applications, make all rightful oaths, and generally do everything possible to aid the said ASSIGNEE, its

successors, legal representatives and assigns, to obtain and enforce proper protection for said invention;

And the ASSIGNOR hereby authorizes the ASSIGNEE's patent attorney to complete this form by the addition of the application number, application filing date, and attorney docket number, if necessary.

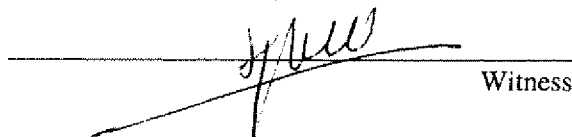
In witness whereof, the inventor has affixed his or her signature.

Date March 18th, 2005



Frederic DUPONT

On March 18th, 2005, before me, Emmanuel Huguier,
Witness, appeared **Frederic DUPONT**, to me known and known to me to be the person of
that name, who signed the foregoing instrument, and acknowledged the same to be his/her
free act and deed.



Witness